Kingbright

57mm (2.3INCH) SINGLE DIGIT NUMERIC DISPLAY

Part Number: SC23-11CGKWA Green

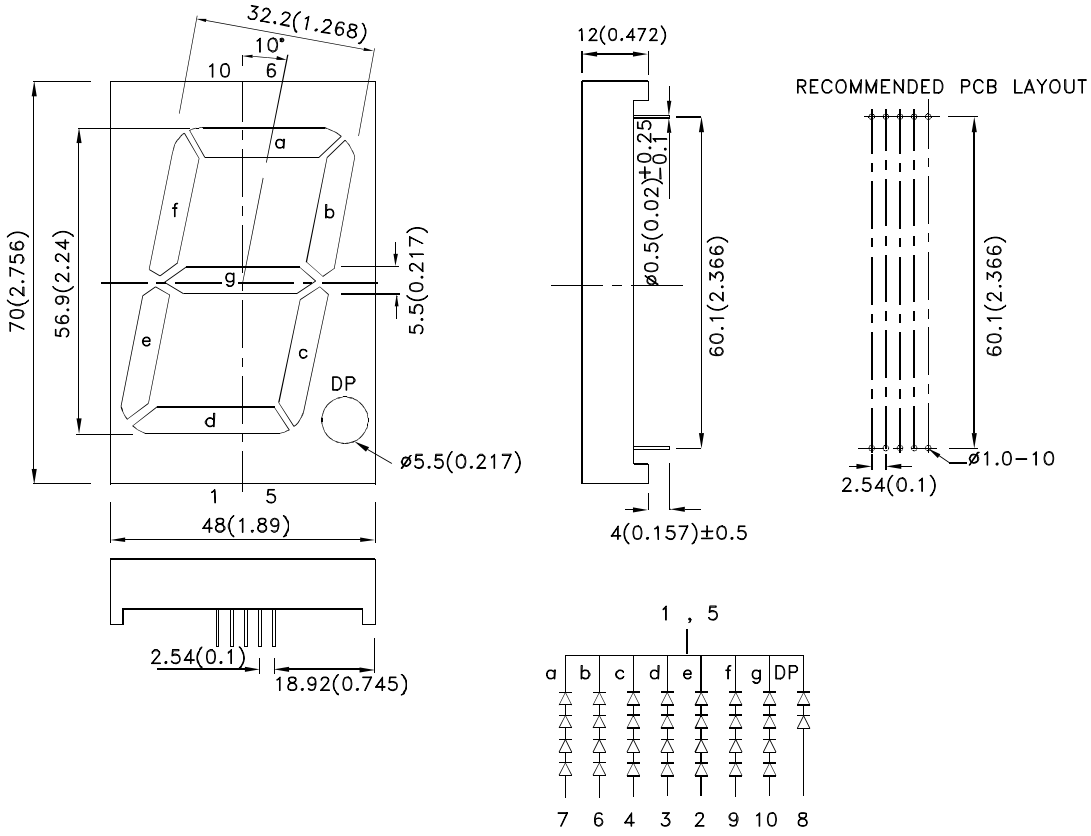
Features

- 2.3 inch digit height.
- Low current operation.
- Excellent character appearance.
- High light output.
- Easy mounting on P.C. boards or sockets.
- Multicolor available.
- Mechanically rugged.
- Standard : gray face, white segment.
- RoHS compliant.

Description

The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

Package Dimensions& Internal Circuit Diagram



Notes:
1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.
2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

Selection Guide

Part No.	Dice	Lens Type	Iv (ucd) [1] @ 10mA		Description
			Min.	Typ.	
SC23-11CGKWA	Green (AlGaInP)	White Diffused	88000	200000	Common Cathode,Rt. Hand Decimal.
			*31000	*62000	

Note:
1. Luminous Intensity / Luminous Flux: +/-15%.
*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at T_A=25°C

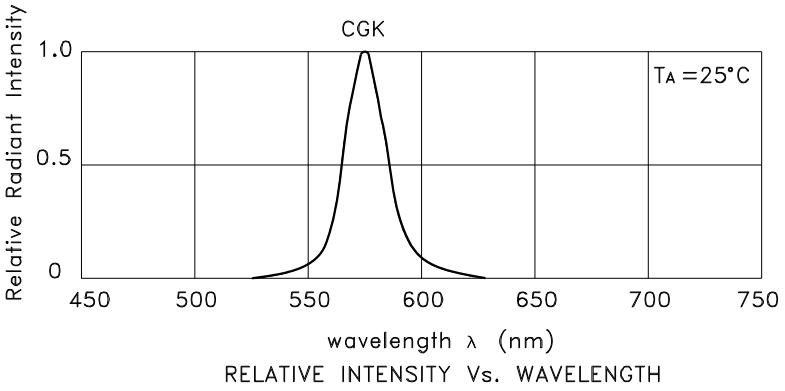
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ peak	Peak Wavelength	Green	574		nm	I_F=20mA
λ D [1]	Dominant Wavelength	Green	570		nm	I_F=20mA
$\Delta\lambda$ 1/2	Spectral Line Half-width	Green	20		nm	I_F=20mA
C	Capacitance	Green	15		pF	V_F=0V;f=1MHz
V_F [2]	Forward Voltage (DP)	Green	8.4 (4.2)	10.0 (5.0)	V	I_F=20mA
I_R	Reverse Current (Per chip)	Green		10	uA	V_R = 5V

Notes:
1.Wavelength: +/-1nm.
2.Forward Voltage: +/-0.1V.
3.Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at T_A=25°C

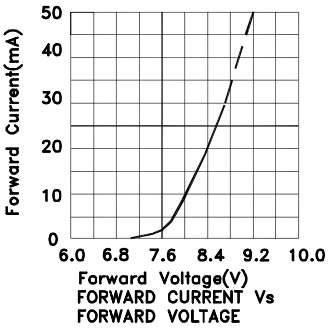
Parameter	Green	Units
Power dissipation (DP)	300 (150)	mW
DC Forward Current	30	mA
Peak Forward Current [1]	150	mA
Reverse Voltage (Per chip)	5 (5)	V
Operating / Storage Temperature	-40°C To +85°C	
Lead Solder Temperature[2]	260°C For 3 ~5 Seconds	

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.

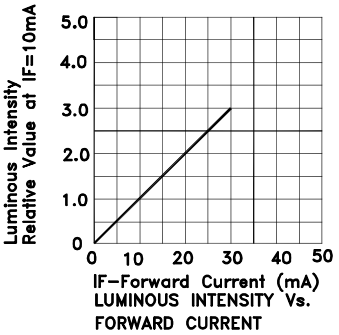


RELATIVE INTENSITY Vs. WAVELENGTH

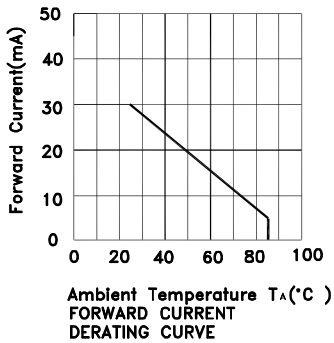
Green **SC23-11CGKWA**



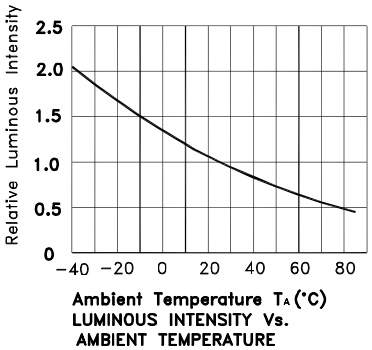
FORWARD CURRENT Vs
FORWARD VOLTAGE



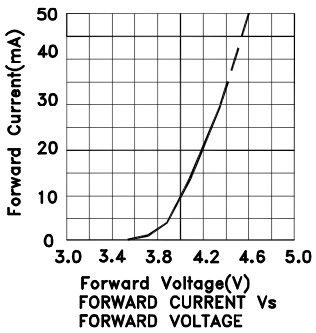
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



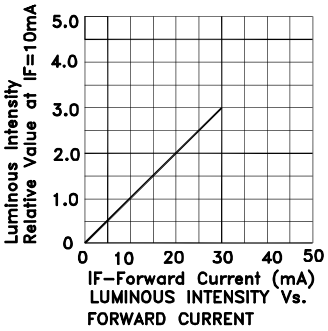
FORWARD CURRENT
DERATING CURVE



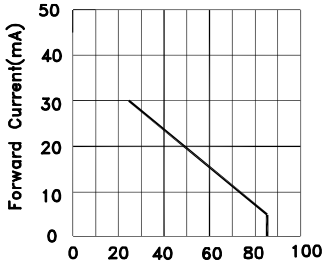
LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



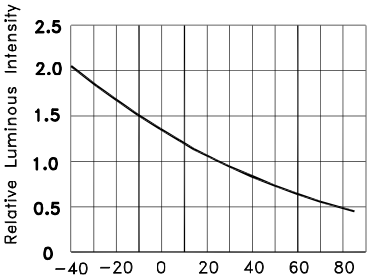
FORWARD CURRENT Vs
FORWARD VOLTAGE



LUMINOUS INTENSITY Vs.
FORWARD CURRENT

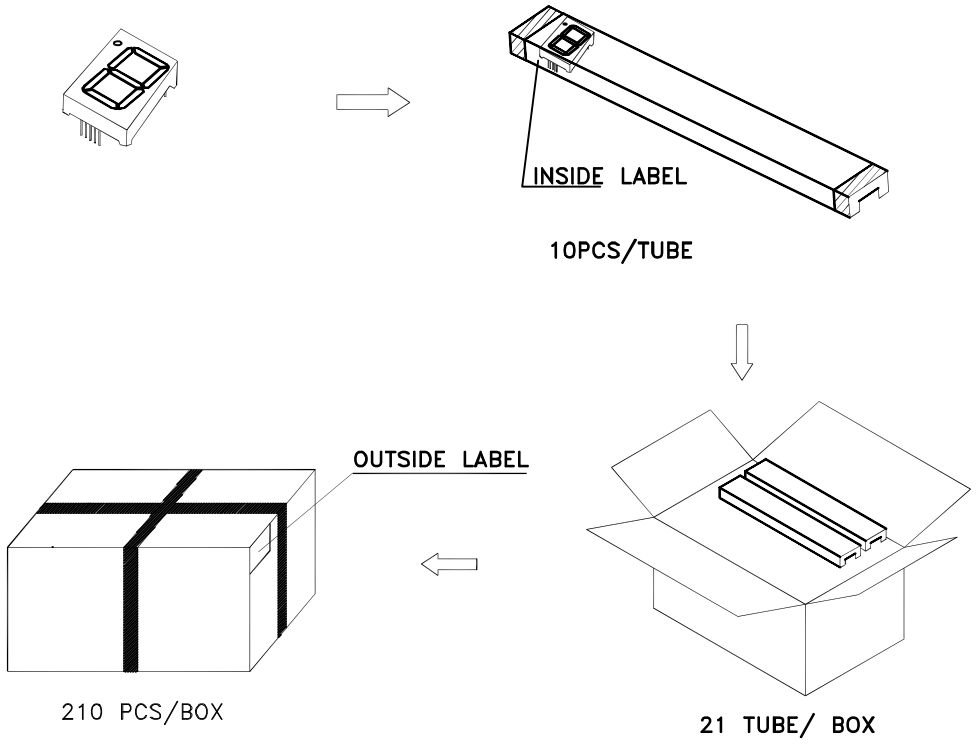


FORWARD CURRENT
DERATING CURVE

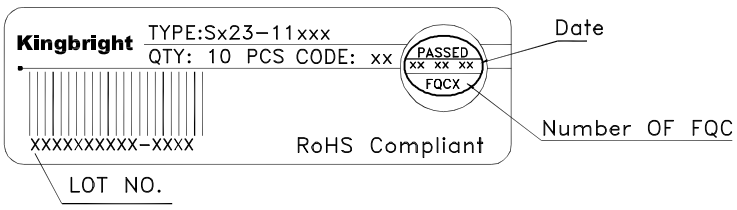


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

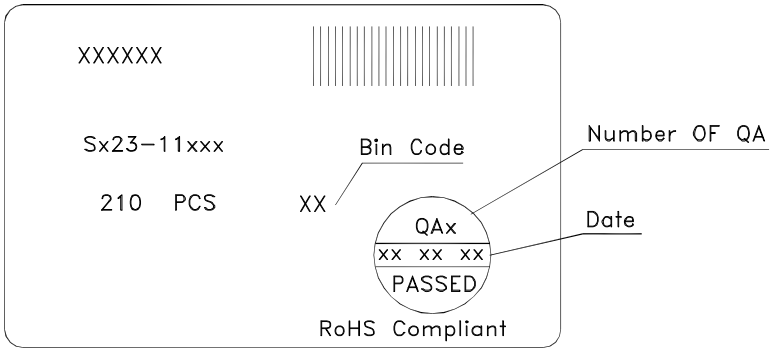
PACKING & LABEL SPECIFICATIONS **SC23-11CGKWA**



Inside Label on Ic-Tube



Outside Label on Box

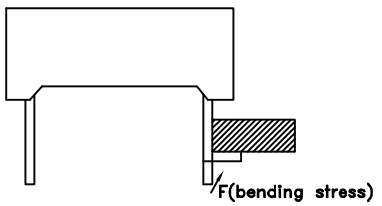


THROUGH HOLE DISPLAY MOUNTING METHOD

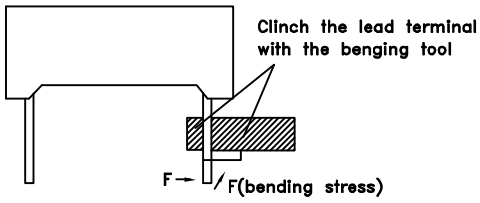
Lead Forming

Do not bend the component leads by hand without proper tools.

The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.



Not Recommended

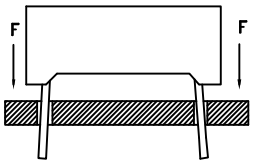


Recommended

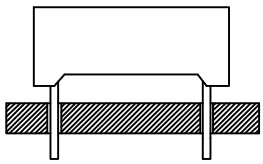
Installation

1.The installation process should not apply stress to the lead terminals.

2.When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.

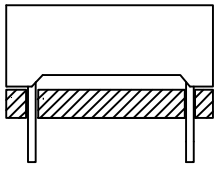


Not Recommended

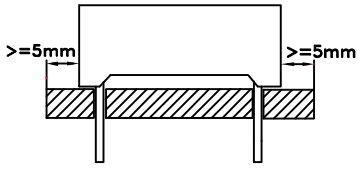


Recommended

3.The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.



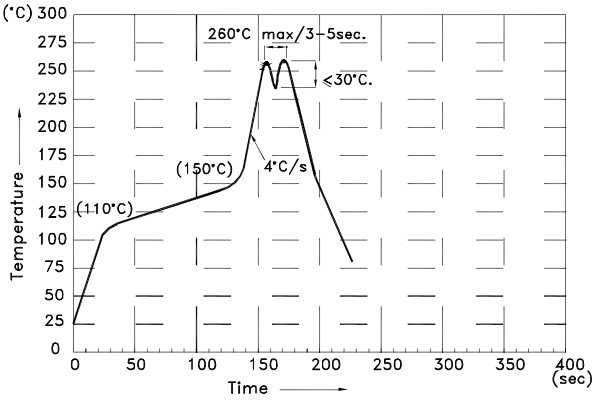
Not Recommended



Recommended

DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
2.Do not apply stress on epoxy resins when temperature is over 85°C.
3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4.During wave soldering , the PCB top-surface temperature should be kept below 105°C
5.No more than once.

Soldering General Notes:

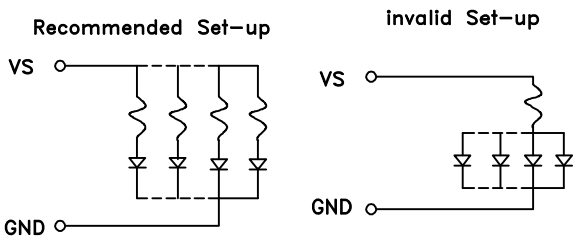
1. Through-hole displays are incompatible with reflow soldering.
2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

CLEANING

1.Mild "no-clean" fluxes are recommended for use in soldering.
2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts .And the devices should not be washed for more than one minute.

CIRCUIT DESIGN NOTES

1.Protective current-limiting resistors may be necessary to operate the Displays.
2.LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



Detailed application notes are listed on our website.
http://www.kingbright.com/application_notes